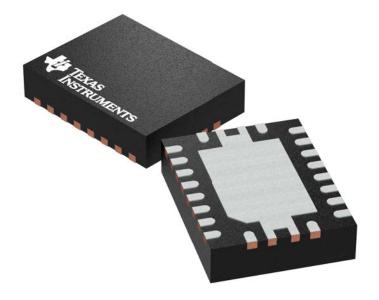
### **RHL 20**

#### 3.5 x 4.5 mm, 0.5 mm pitch

## **GENERIC PACKAGE VIEW**

# VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



Images above are just a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



4205346/L

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